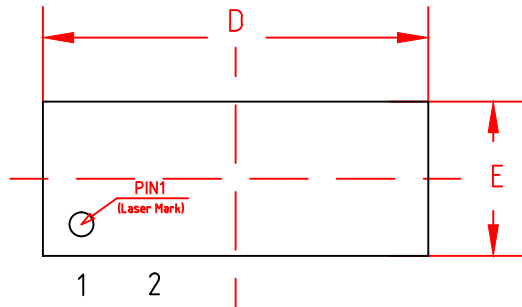
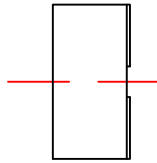


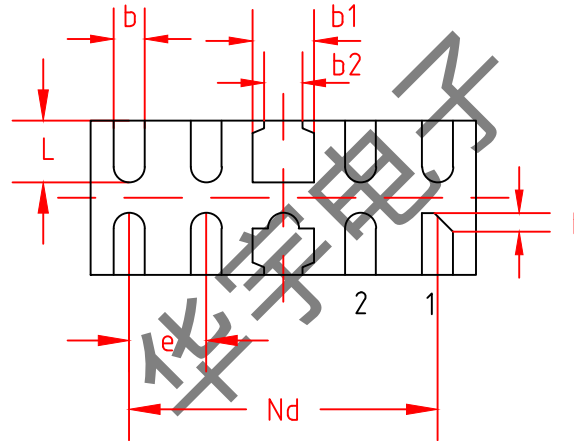
TOP VIEW
正视图



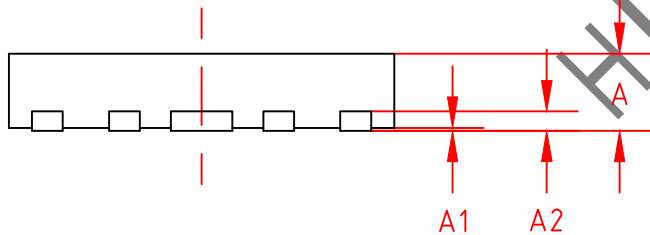
SIDE VIEW
侧视图




BOTTOM VIEW
背视图



SIDE VIEW
侧视图



机械尺寸/mm			
字符 SYMBOL	最小值 MIN	典型值 NOMINAL	最大值 MAX
A	0.45	0.50	0.55
A1	-	0.02	0.05
A2	0.127 REF		
b	0.15	0.20	0.25
b1	0.35	0.40	0.45
b2	0.20	0.25	0.30
D	2.45	2.50	2.55
E	0.95	1.00	1.05
e	0.50 BSC		
L	0.35	0.40	0.45
h	0.12 (45°) BSC		
Nd	2.00 BSC		

 池州华宇电子科技股份有限公司 CHI ZHOU HI SEMI ELECTRONICS TECHNOLOGY CO.,LTD				制图: Draw	李家通 2022. 04. 29
图号 Drawing NO.	HY-POD-DFN102510002			制图核查: Drawing review	
Title 产品外形图	PACKAGE OUTLINE DIMENSIONS DFN10L (2.5×1.0×0.5-P0.5)C			审核: Checker	
幅图 size	页数 page	单位 unit	比例 scale	视图 view	核准: Approved
A4	1	mm	1:1	